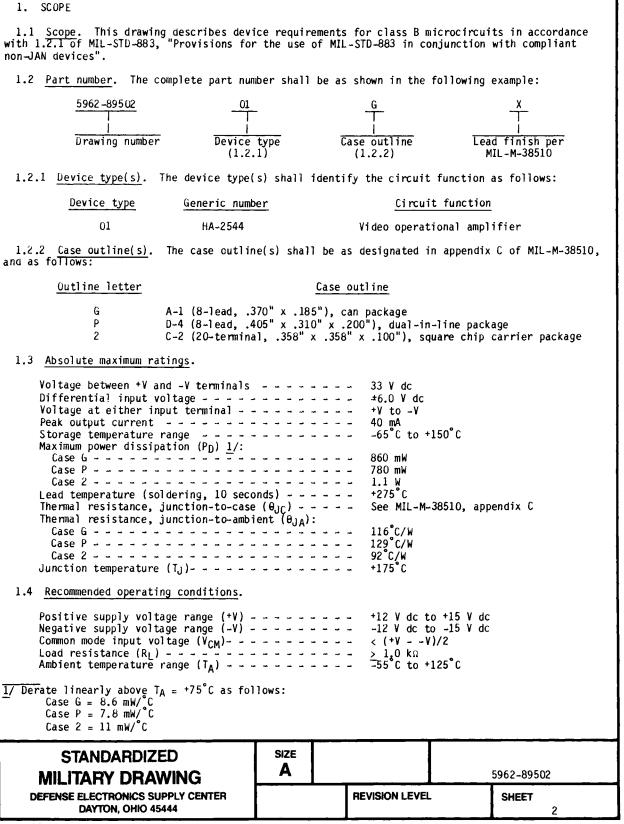
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2. APPLICABLE DOCUMENTS

2.1 Government specification, standard, and bulletin. Unless otherwise specified, the following specification, standard, and bulletin of the issue listed in that issue of the Department of Defense Index of Specifications and Standards specified in the solicitation, form a part of this drawing to the extent specified herein.

SPECIFICATION

MILITARY

MIL-M-38510

- Microcircuits, General Specification for.

STANDARD

MILITARY

MIL-STD-883

- Test Methods and Procedures for Microelectronics.

BULLETIN

MILITARY

MIL-BUL-103

- List of Standardized Military Drawings (SMD's).

(Copies of the specification, standard, and bulletin required by manufacturers in connection with specific acquisition functions should be obtained from the contracting activity or as directed by the contracting activity.)

2.2 Order of precedence. In the event of a conflict between the text of this drawing and the references cited herein, the text of this drawing shall take precedence.

REQUIREMENTS

- 3.1~ Item requirements. The individual item requirements shall be in accordance with 1.2.1~ of MIL-STD-883, "Provisions for the use of MIL-STD-883 in conjunction with compliant non-JAN devices" and as specified herein.
- 3.2 Design, construction, and physical dimensions. The design, construction, and physical dimensions shall be as specified in MIL-M-38510 and herein.
 - 3.2.1 Terminal connections. The terminal connections shall be as specified on figure 1.
 - 3.2.2 Case outlines. The case outlines shall be in accordance with 1.2.2 herein.
- 3.3 Electrical performance characteristics. Unless otherwise specified herein, the electrical performance characteristics are as specified in table I and apply over the full ambient operating temperature range.
- 3.4 Electrical test requirements. The electrical test requirements shall be the subgroups specified in table II. The electrical tests for each subgroup are described in table I.
- 3.5 Marking. Marking shall be in accordance with MIL-STD-883 (see 3.1 herein). The part shall be marked with the part number listed in 1.2 herein. In addition, the manufacturer's part number may also be marked as listed in MIL-BUL-103 (see 6.6 herein).

STANDARDIZED MILITARY DRAWING	SIZE A		5962 -89502
DEFENSE ELECTRONICS SUPPLY CENTER DAYTON, OHIO 45444		REVISION LEVEL	SHEET 3

TABL	E I. <u>E</u>	lectr	ical perf	rmance	e characteristic	<u>s</u> .			
Test	 Symbol	 -\/ =	> 55°C. - 15 ۷, -	nditio TA < V = -1 erwise	ns +125°C <u>1</u> / 5 V, C _L <u><</u> 10 pF specified	 Group A subgroups 	Lin Min	nits Max	 Unit
Input offset voltage	VIO	VCM	= 0 V			1	 	±15	 mV
	<u> </u>	<u> </u>				2, 3		±20	<u>i</u>
Input bias current	+1 _B 	V _{CM} -R _S	= 0 V, $+R$ = 10Ω	s = 1.	0 kΩ,	1	İ	±15	μ Α
	 -I _B	IV _{CM}	= 0 V, +R = 1.0 kΩ	S = 10	Ω,	2, 3		±20 ±15] μΑ
Toronto official and a	<u> </u> 					2, 3		±20	
Input offset current	 1		$= 0 \text{ V, } +R$ $= 1.0 \text{ k}\Omega$	ς = 1.	υ κ Ω,	2, 3		±2.0 ±3.0	1
Common mode voltage range	I+V _{CM}	 +V =	+5.0 V,	-V = -	25 V	1, 2, 3	10		V
	I-ACW	+V =	+25 V, -	V = -5	.o v	1, 2, 3	-10		V
Large signal voltage gain	I+A _{VOL}		r = 0 V an : 1 kΩ	d +10	٧,	4	3.5		 kV/V
	 -Avol	 ¥0UT	r = 0 V an	d -10	v	5, 6	3.5		 kV/V
		IKL =	= 1 kΩ			5, 6	2.5	 	
Common mode rejection ratio	+CMRR	- V =	y = +10 V, = -25 V, V	+V = OUT =	+5.0 V, -10 V	1, 2, 3	75 		dB
	-CMRR	~ A =	w = -10 V, = -5.0 V,	+V = V _{OUT} =	+25 V, +10 V	1, 2, 3	 75 		dB
Output current	+I _{OUT}	Ι Ιν _{ου} τ Ι	r = +10 V,	T _A =	+25°C	 4 	 25	 	l mA
	-I _{OUT}	V _{OU1}	r = -10 V,	TA =	+25°C	 4 	-25		mA
Output voltage swing	I+V _{OUT}	R _L :	= 1 kΩ			4, 5, 6	+10.0) V
	-V _{OUT}	RL :	= 1 kΩ			4, 5, 6	 -10.0	! !	 V
See footnotes at end of table									
STANDARDIZED			SIZE			-	062.005	00	
MILITARY DRAWII DEFENSE ELECTRONICS SUPPL DAYTON, OHIO 45444					REVISION LEVEL		962-895 SHEET	1	

TABLE I.	Electr	ical	performanc	e chara	acteristics - (Continued.			
Test	Symbol	 +V = u	Con -55°C < +15 V, =V nless othe	= -15	s 125°C <u>1</u> / V, C _L < 10 pF specified	 Group A subgroups 		mits Max	 Unit
Quiescent power supply current	+ICC	VOUT	= 0 V, I ₀	out = 0	mA	1, 2, 3		12	mA
	-ICC	V _{OUT}	= 0 V, I ₀	out = 0	mA	1, 2, 3		-12	mA
Power supply rejection ratio	+PSRR	+γ =	+10 V and	+20 V	, -V = -15 V	1, 2, 3	70		dB
	-PSRR	-V = -10 V and $-20 V$, $+V = +15$				1 1, 2, 3	70	ľ	dB
Offset voltage adjustment	(ADJ)	1	+25°C	2/			V ₁₀		l mV
	 -VIO (ADJ)	 T _A =	+25°C	<u>2</u> /			1,41.0		l mV
Slew rate	 +SR	I Vout	= -3.0 V	to +3.0) V	_	100	ŀ	lV/μs
	 	R _S = A _V =	100Ω , $R_L = 1 k\Omega$, $1 V/V$			8	 70 	 	Γ
	-SR	VOUT	/ _{OUT} = +3.0 V to -3.0 V				100		 V/μs
	 		100Ω, R _L : 1 V/V	= 1 kΩ,	•	8	70	 	Γ
Differential gain 7/	i dAy	$ f_0 =$	= 50Ω , R_{L} = $1.0 \text{ k}\Omega$, = 3.58 MHz and 4.43 MHz		ì, 3 MHz	4		.04	dB
Differential phase 7/	i dø	ITĂ = I	+25°C			4		.11	de- grees
Unity gain bandwidth	UGBW	V _{OUT}	= 200 mV, +25°C	fat -	-3.0 dB,	4	45	 	MHz MHz
Gain tolerance 7/	 ΔΑγ 	f ₀ =	5.0 MHz,	T _A = +2	25°C	4		±.15	dB
	 	 f ₀ =	10 MHz, T,	A = +25	5°C	4		±.35	dB
Full power bandwidth 4/	 FPBW 	 V _{PK}	$V_{PK} = 1.0 \text{ V}, R_{L} = 1 \text{ k}\Omega,$ $V_{A} = +25 \text{ C}$				15.9	 	MHz
	 		= 5.0 V, R _l +25°C	= 1 k	Ω,	4	3.2		MHz
See footnotes at end of table	e.				'			1	
STANDARDIZED MILITARY DRAW			SIZE A			į	5962-89	502	•
DEFENSE ELECTRONICS SUPP DAYTON, OHIO 45444	LY CENTE	9			REVISION LEVEL		SHEET	5	

TABLE I.	Electric	cal performance characteristics - Co	ntinued.			
Test	Symbol	Conditions	Group A	Lin	nits	 Unit
		Conditions $\begin{array}{cccccccccccccccccccccccccccccccccccc$	subgroups 	Min	Max	
Closed loop stable gain $3/$	CLSG	R _L = 1.0 kΩ, C _L <u><</u> 1.0 pF	4, 5, 6	+1.0		V/V
Rise time <u>5</u> /	tr	V _{OUT} = 0 V to +200 mV	9		15	ns
	<u> </u>		10, 11 3/		15	<u>T</u>
Fall time $\underline{5}/$	tf	V _{OUT} = 0 V to -200 mV	9		15	ns
	! <u> </u>		$10, 11^{\frac{3}{1}}$		15	1
Overshoot	 +0S	$V_{OUT} = 0 V \text{ to } +200 \text{ mV}$	9		20	1 %
			10, 11 ³ /		30	T
	 -0S	V _{OUT} = 0 V to -200 mV	9	ĺ	20	1 %
	<u> </u>		10, 11 ^{3/}		30	
Output resistance 3/	ROUT	 T _A = +25°C	4		40	Ω
Quiescent power consumption 6/	I _{PC}	$V_{OUT} = 0 V$, $I_{OUT} = 0 \text{ mA}$	1, 2, 3	İ	360	l mW

- I/ For DC tests (subgroups 1, 2, and 3): RS = 10Ω , RL = $500~k\Omega$, V_{OUT} = 0 V unless otherwise specified. For AC tests (subgroups 4, 5, 6, 7, 8, 9, 10, 11): Ay = +1.0 V/V, R_L = 1 k Ω , unless otherwise specified.
- $^{2/}$ Offset adjustment range is V $_{10}$ (measured) ±1.0 mV minimum referred to output. This test is for functionality only to assure adjustment through 0 V.
- $\underline{3}$ / If not tested, shall be guaranteed to the limits specified in table I.
- $\frac{4}{}$ Full power bandwidth = $\frac{SR}{2\pi}$.
- $\frac{5}{2}$ Rise and fall times measured between 10 percent and 90 percent point.
- 6/ Quiescent power consumption based on quiescent supply current test maximum (no load on outputs).
- $\overline{2}$ / Sample tested on every lot to a LTPD = 5.

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Device type		01							
Case outlines	G and P	2							
Terminal number	Terminal symbol								
1 2 3 4 5 6 7 8 9 10 11 12 13 14 15 16 17 18 19 20	Balance -IN +IN -V Balance Output +V No connection	No connection Balance No connection No connection -1N No connection +1N No connection -V No connection Balance No connection No connection Output No connection +V No connection +V No connection No connection No connection No connection							

FIGURE 1. Terminal connections.

STANDARDIZED MILITARY DRAWING	SIZE A	T	5962-89502		
DEFENSE ELECTRONICS SUPPLY CENTER DAYTON, OHIO 45444		REVISION LEVEL	SHEET 7		

- 3.6 Certificate of compliance. A certificate of compliance shall be required from a manufacturer in order to be listed as an approved source of supply in MIL-BUL-103 (see 6.6 herein). The certificate of compliance submitted to DESC-ECS prior to listing as an approved source of supply shall affirm that the manufacturer's product meets the requirements of MIL-STD-883 (see 3.1 herein) and the requirements herein.
- 3.7 Certificate of conformance. A certificate of conformance as required in MIL-STD-883 (see 3.1 herein) shall be provided with each lot of microcircuits delivered to this drawing.
- 3.8 Notification of change. Notification of change to DESC-ECS shall be required in accordance with MIL-STD-883 (see 3.1 herein).
- 3.9 <u>Verification and review</u>. DESC, DESC's agent, and the acquiring activity retain the option to review the manufacturer's facility and applicable required documentation. Offshore documentation shall be made available onshore at the option of the reviewer.
 - 4. QUALITY ASSURANCE PROVISIONS
- 4.1 Sampling and inspection. Sampling and inspection procedures shall be in accordance with section 4 of MIL-M-38510 to the extent specified in MIL-STD-883 (see 3.1 herein).
- 4.2 <u>Screening</u>. Screening shall be in accordance with method 5004 of MIL-STD-883, and shall be conducted on all devices prior to quality conformance inspection. The following additional criteria shall apply:
 - a. Burn-in test, method 1015 of MIL-STD-883.
 - Test condition A, B, C, or D using the circuit submitted with the certificate of compliance (see 3.6 herein).
 - (2) $T_A = +125$ °C, minimum.
 - b. Interim and final electrical test parameters shall be as specified in table II herein, except interim electrical parameter tests prior to burn-in are optional at the discretion of the manufacturer.
- 4.3 Quality conformance inspection. Quality conformance inspection shall be in accordance with method $\overline{5005}$ of MIL-STD-883 including groups A, B, C, and D inspections. The following additional criteria shall apply.
 - 4.3.1 Group A inspection. Tests shall be as specified in table II herein.
 - 4.3.2 Groups C and D inspections.
 - a. End-point electrical parameters shall be as specified in table II herein.
 - b. Steady-state life test conditions, method 1005 of MIL-STD-883:
 - Test condition A, B, C, or D using the circuit submitted with the certificate of compliance (see 3.6 herein).
 - (2) $T_A = +125$ °C, minimum.
 - (3) Test duration: 1,000 hours, except as permitted by method 1005 of MIL-STD-883.

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TABLE II. Electrical test requirements.

MIL-STD-883 test requirements	Subgroups (per method 5005, table I)
Interim electrical parameters (method 5004)	
Final electrical test parameters (method 5004)	1 1*,2,3,4,5,6,7
Group A test requirements (method 5005)	 1,2,3,4,5,6,7, 8**,9,10**,11**
Groups C and D end-point electrical parameters (method 5005)	1

PDA applies to subgroup 1. Subgroups 8, 10, and 11 guaranteed if not tested.

5. PACKAGING

5.1 Packaging requirements. The requirements for packaging shall be in accordance with MIL-M-38510.

6. NOTES

- 6.1 Intended use. Microcircuits conforming to this drawing are intended for use when military specifications do not exist and qualified military devices that will perform the required function are not available for OEM application. When a military specification exists and the product covered by this drawing has been qualified for listing on QPL-38510, the device specified herein will be inactivated and will not be used for new design. The QPL-38510 product shall be the preferred item for all applications.
- 6.2 Replaceability. Microcircuits covered by this drawing will replace the same generic device covered by a contractor-prepared specification or drawing.
- 6.3 Configuration control of SMD's. All proposed changes to existing SMD's will be coordinated with the users of record for the individual documents. This coordination will be accomplished in accordance with MIL-STD-481 using DD Form 1693, Engineering Change Proposal (Short Form).
- 6.4 Record of users. Military and industrial users shall inform Defense Electronics Suppy Center when a system application requires configuration control and the applicable SMD. DESC will maintai a record of users and this list will be used for coordination and distribution of changes to the drawings. Users of drawings covering microelectronics devices (FSC 5962) should contact DESC-ECS, telephone (513)-296-6022
- 6.5 Comments. Comments on this drawing should be directed to DESC-ECS, Dayton, Ohio 45444, or telephone 513-296-5375.
- 6.6 Approved sources of supply. Approved sources of supply are listed in MIL-BUL-103. Additional sources will be added to MIL-BUL-103 as they become available. The vendor listed in MIL-BUL-103 have agreed to this drawing and a certificate of compliance (see 3.6 herein) has been submitted to and accepted by DESC-ECS.

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STANDARDIZED MILITARY DRAWING SOURCE APPROVAL BULLETIN

DATE: 91-03-22

Approved sources of supply for SMD 5962-89502 are listed below for immediate acquisition only and shall be added to MIL-BUL-103 during the next revision. MIL-BUL-103 will be revised to include the addition or deletion of sources. The vendors listed below have agreed to this drawing and a certificate of compliance has been submitted to and accepted by DESC-ECS. This bulletin is superseded by the next dated revision of MIL-BUL-103.

Standardized military drawing PIN	Vendor CAGE number	 Vendor similar PIN <u>1</u> /
5962-8950201GX	34371	 HA2-2544/883
5962-8950201PX	34371	 HA7-2544/883
5962-89502012X	34371 	 HA4-2544/883

Do not use this number for item acquisition. Items acquired to this number may not satisfy the performance requirements of this drawing.

Vendor CAGE number

34371

Vendor name and address

Harris Semiconductor P.O. Box 883 Melbourne, FL 32901

The information contained herein is disseminated for convenience only and the Government assumes no liability whatsoever for any inaccuracies in this information bulletin.